



# **PRODUCT DATASHEET**



- ► PCB / CHIP LED
- ▶ 0402 (1005) 0.5t
- Natural White (4500K)



# 0402 0.5t Series



# **FEATURES:**

- Package: PCB / CHIP Top View SMT LED
- Forward Current: 20mA
- Forward Voltage (typ.): 3.1V
- Luminous Intensity (typ.): 220mcd@20mA
  - Colour: Natural White
- **CCT:** 4500K

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- Viewing angle: 150°
- Materials:
  - Die: InGaN
  - Resin: Epoxy (Yellow Diffused)
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+85°C
- Grouping parameters:
  - Forward voltage
  - Luminous intensity
  - CIE Chromaticity
- Soldering methods: Reflow soldering
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with max.5000/reel, ø180mm (7")

# N0W50S49

0402 0.5t Series

# **APPLICATIONS:**

- LED Display Backlighting
- Indicator
- Consumer Goods
- 3C Products



# CHARACTERISTICS:

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lf	30	mA
Peak Forward Current Duty 1/8@1KHz	IFP	125	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	IR	10	μΑ
Power Dissipation	PD	111	mW
Operating Temperature	Topr	-40~+80	°C
Storage Temperature	T <sub>STG</sub>	-40~+85	°C

## Electrical & Optical Characteristics (Ta=25°C)

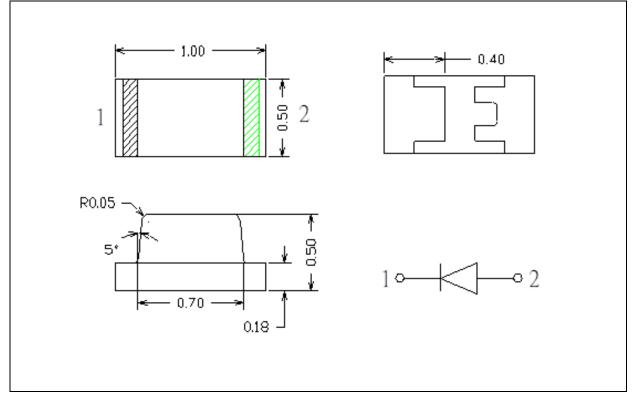
Parameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition	
Forward Voltage	VF	2.8	3.1	3.7	V	I⊧=20mA	
Luminous Intensity	lv	125	220	400	mcd	I⊧=20mA	
Chromaticity	х		0.3570			l⊧=20mA	
Coordinates	Y		0.3580				
Colour Temperature	ССТ	3600		5800	к	I⊧=20mA	
Viewing Angle	2 <b>0</b> 1/2		150		deg	I⊧=20mA	

1. Luminous intensity (I<sub>V</sub>) ±15%, Forward Voltage (V<sub>F</sub>) ±0.1V, Viewing angle( $2\theta_{1/2}$ ) ±5%



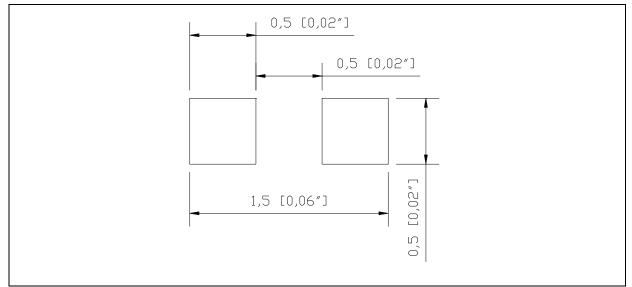
## **OUTLINE DIMENSION:**

### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

#### **Recommended Soldering Pad Dimension:**



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



## **BINNING GROUPS:**

Code	Min.	Max.	Unit
f	2.8	3.1	
g	3.1	3.4	V
h	3.4	3.7	

#### Forward Voltage Classifications ( $I_F = 20mA$ ):

## Luminous Intensity Classifications (I<sub>F</sub> = 20mA):

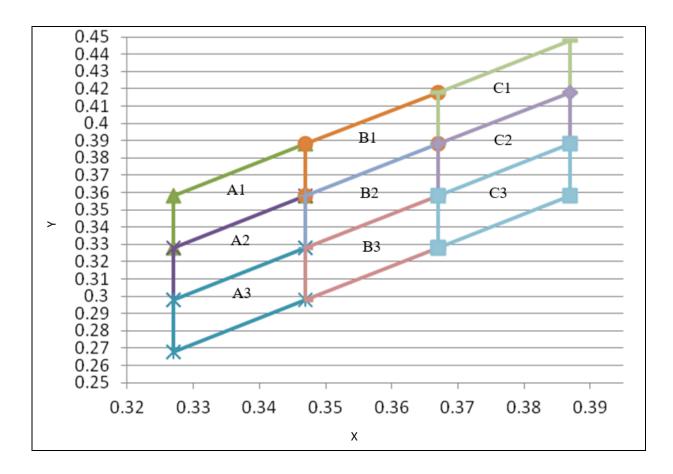
Code	Min.	Max.	Unit
К	125	160	
L	160	200	
М	200	250	mcd
N	250	320	
0	320	400	

Example Group Name on Label:

gMB2 20 = g (3.1~3.4V) ► M (200~250mcd) ► B2 (X(0.3470~0.3670)/Y(0.3280~0.3880) ► 20 (IF=20mA)



## **CIE CHROMATICITY DIAGRAM:**

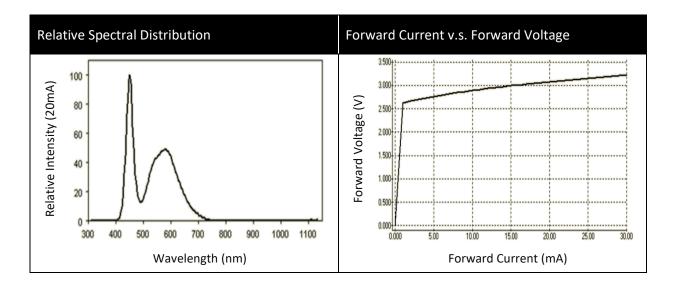


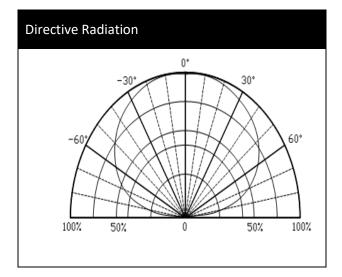
### Chromaticity Coordinates Classifications (I<sub>F</sub> = 20mA):

	Ĩ	L	2		3		4	
	Х	Y	Х	Y	х	Y	Х	Y
A1	0.3270	0.3280	0.3270	0.3580	0.2470	0.2880	0.2470	0.2580
A2	0.3270	0.2980	0.3270	0.3280	0.3470	0.3580	0.3470	0.3280
A3	0.3270	0.2680	0.3270	0.2980	0.3470	0.3280	0.3470	0.2980
B1	0.3470	0.3580	0.3470	0.3880	0.3670	0.4180	0.3670	0.3880
B2	0.3470	0.3280	0.3470	0.3580	0.3670	0.3880	0.3670	0.3580
B3	0.3470	0.2980	0.3470	0.3280	0.3670	0.3580	0.3670	0.3280
C1	0.3670	0.3880	0.3670	0.4180	0.3870	0.4480	0.3870	0.4180
C2	0.3670	0.3580	0.3670	0.3880	0.3870	0.4180	0.3870	0.3880
С3	0.3670	0.3280	0.3670	0.3580	0.3870	0.3880	0.3870	0.3580



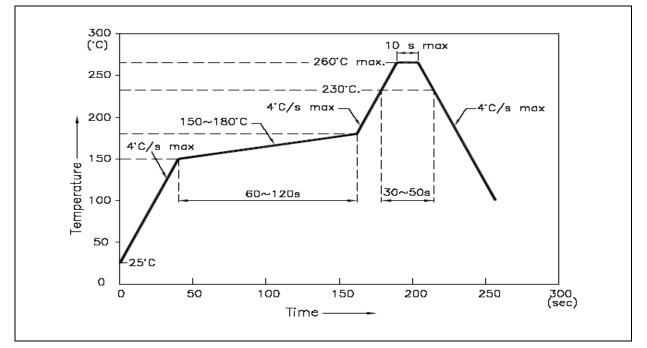
## **ELECTRO-OPTICAL CHARACTERISTICS:**







## **RECOMMENDED SOLDERING PROFILE:**



Lead-free Solder:

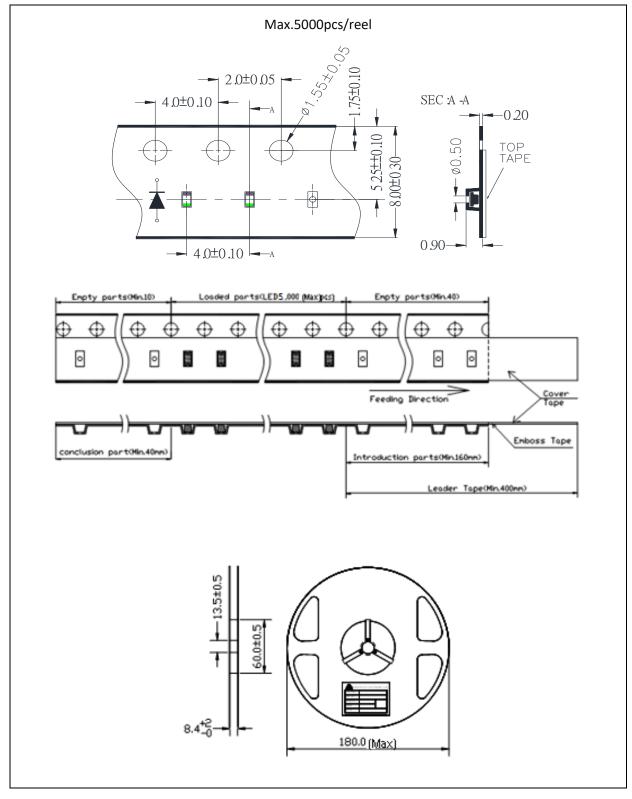
Note:

- 1. Recommend reflow temperature 245°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



# **PACKING SPECIFICATION:**

### Reel Dimension:



## **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking before use.

#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24 hours. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	12/12/2019	Datasheet set-up.